



FEATURES

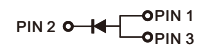
- * Low forward voltage drop
- * High current capability
- * High reliability
- * High surge current capability
- * Epitaxial construction

MECHANICAL DATA

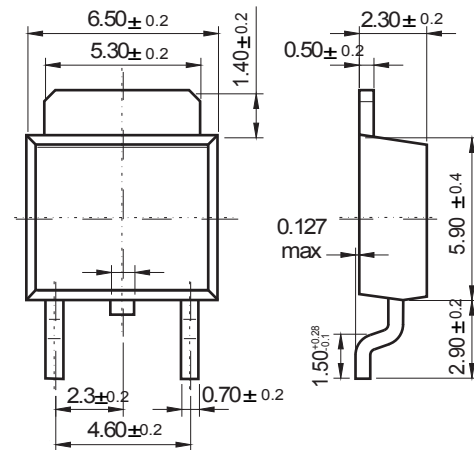
- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Lead: Lead solderable per MIL-STD-202, method 208 guaranteed
- * Polarity: As Marked
- * Mounting position: Any
- * Weight: 2.24 grams

VOLTAGE RANGE	100 Volts
CURRENT	20.0 Ampere

TO-252



Unit: mm



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25 °C ambient temperature unless otherwise specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

TYPE NUMBER	MBRD20L100	UNITS
Maximum Recurrent Peak Reverse Voltage	100	V
Maximum RMS Voltage	70	V
Maximum DC Blocking Voltage	100	V
Maximum Average Forward Rectified Current		
See Fig. 1	20.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	200	A
Maximum Instantaneous Forward Voltage at 20.0A	0.7	V
Maximum DC Reverse Current Ta=25°C	0.1	mA
at Rated DC Blocking Voltage Ta=125°C	20	mA
Typical Junction Capacitance (Note1)	600	pF
Typical Thermal Resistance R JA (Note 2)	60	°C/W
Operating Temperature Range Tj	-55 to +150	°C
Storage Temperature Range Tstg	-55 to +150	°C

Note : 1.FR-4 PCB, 2oz.Copper.
2.Polyimide PCB, 2oz.Copper.Cathode pad dimensions 18.8mm x 14.4mm.Anode pad dimensions 5.6mm x 14.4mm.

RATING AND VCHARACTERISTIC CURVES(MBRD20L100)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

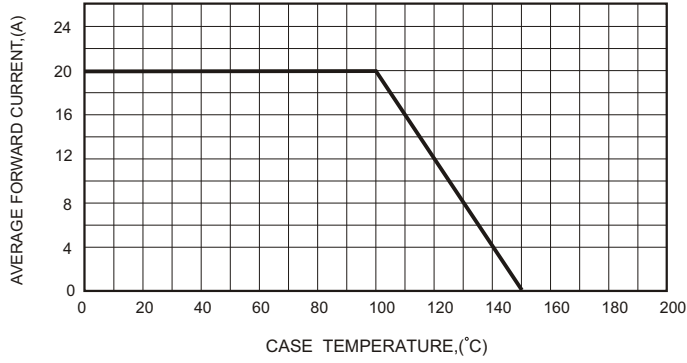


FIG.2-TYPICAL FORWARD CHARACTERISTICS

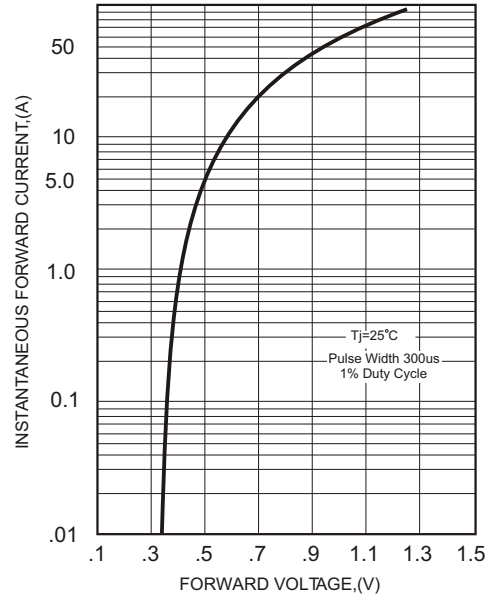


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

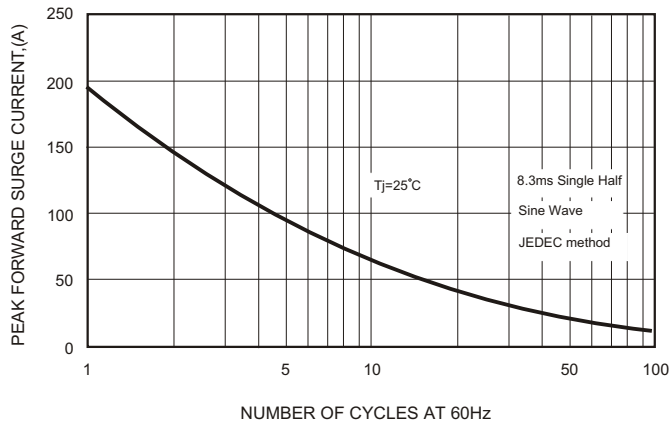


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

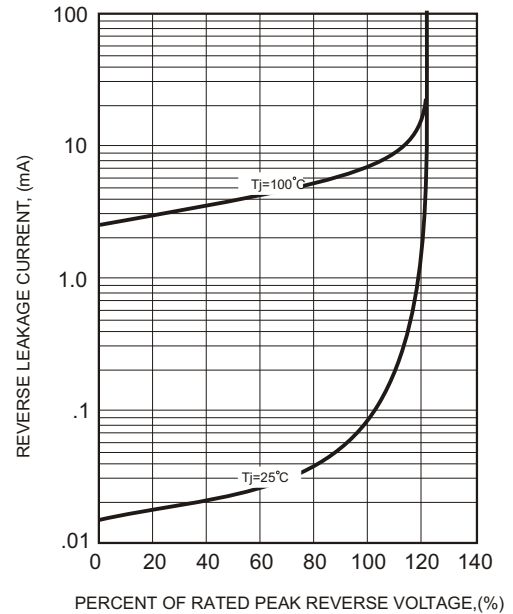


FIG.4-TYPICAL JUNCTION CAPACITANCE

